

QUADRUPLE 3-STATE BUFFERS

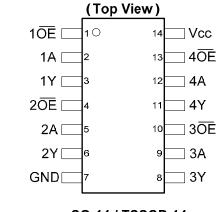
Description

The 74LVC125A provides four independent buffers with three state outputs. Each output is independently controlled by an associated output enable pin (OE) which places the device in the high impedance state when driven high. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using IOFF. The IOFF circuitry disables the output preventing damaging current backflow when the device is powered down.

Features

- Supply Voltage Range from 1.65V to 5.5V
- Sinks 24mA at Vcc = 3.3V
- CMOS low power consumption
- IOFF Supports Partial-Power-Down Mode Operation
- Inputs or outputs accept up to 5.5V
- Inputs can be driven by 3.3V or 5.5V allowing for voltage translation applications.
- ESD Protection Exceeds JESD 22
 - 200-V Machine Model (A115-A)
 - 2000-V Human Body Model (A114-A)
 - Exceeds 1000-V Charged Device Model (C101C)
- Latch-Up Exceeds 250mA per JESD 78, Class II
- Range of Package Options SO-14 and TSSOP-14
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Pin Assignments



SO-14 / TSSOP-14

Applications

- Voltage Level Shifting
- General Purpose Logic
- Power Down Signal Isolation
- Wide array of products such as:
 - PCs, networking, notebooks, ultrabooks, netbooks
 - Computer peripherals, hard drives, CD/DVD ROM
 - TV, DVD, DVR, set top box

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

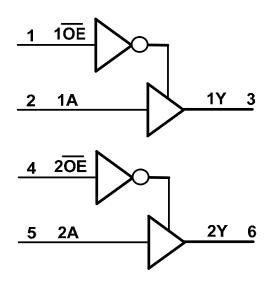
See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

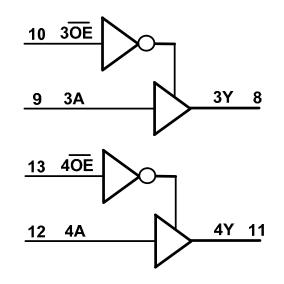


Pin Descriptions

Pin Number	Pin Name	Description	
1	10E	Data Enable Input (active low)	
2	1A	Data Input	
3	1Y	Data Output	
4	20E	Data Enable Input (active low)	
5	2A	Data Input	
6	2Y	Data Output	
7	GND	Ground	
8	3Y	Data Output	
9	3A	Data Input	
10	3OE	Data Enable Input (active low)	
11	4Y	Data Outp	
12	4A	Data Input	
13	40E	Data Enable Input (active low)	
14	V _{CC}	Supply Voltage	

Logic Diagram





Function Table

Inp	Output	
OE	Α	Y
L	н	Н
L	L	L
н	х	Z



Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
Vcc	Supply Voltage Range	-0.5 to 6.5	V
VI	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage applied to output in high impedance or IOFF state	-0.5 to 6.5	V
Vo	Voltage applied to output in high or low state	-0.3 to V _{CC} +0.5	V
I _{IK}	Input Clamp Current VI <0	-50	mA
I _{OK}	Output Clamp Current V _O <0	-50	mA
lo	Continuous output current	±50	mA
I _{CC} , I _{GND} Continuous current through V _{CC} or GND		±100	mA
T _J Operating Junction Temperature		-40 to +150	°C
T _{STG}	Storage Temperature	-65 to +150	°C
P _{TOT}	Total Power Dissipation	500	mW

Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

Note: 4. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

Recommended Operating Conditions (Note 5) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit	
V _{CC}	Supply Voltage		1.65	5.50	V	
VI	Input Voltage		0	5.5	V	
		Active Mode	0	V _{CC}	V	
Vo Output Voltage	Output voltage	Vcc = 0V; Power Down Mode	0	5.5	V	
A. (A) (Less of the contribution of all we to	V _{CC} = 1.65V to 2.7V		20		
Δt/ΔV	Input transition rise or fall rate	V _{CC} = 2.7V to 3.6V		10	ns/V	
T _A	Operating free-air temperature		-40	+125	°C	

Note: 5. Unused inputs should be held at V_{CC} or Ground.



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

				T _A = -40°	C to 85°C	T _A = -40°0	C to 125°C	
Symbol	nbol Parameter Test Conditions		V _{cc}	Min Max		Min	Max	Unit
			1.65V to 1.95V	0.65 X V _{CC}		0.65 X V _{CC}		
VIH	High-level Input Voltage		2.3V to 2.7V	1.7		1.6		V
	Vollage		2.7V to 3.6V	2.0		2.0		
			1.65V to 1.95V		0.35 X V _{CC}		0.35 X V _{CC}	
VIL	Low-level input voltage		2.3V to 2.7V		0.7		0.7	V
	voltage		2.7V to 3.6V		0.8		0.8	
		I _{OH} = -100µА	1.65V to 3.6V	V _{CC} -0.2		$V_{CC} - 0.3$		
		I _{OH} = -4mA	1.65V	1.2				
.,	V _{OH} High Level Output Voltage	I _{OH} = -8mA	2.3V	1.9				V
VOH			2.7V	2.2		2.05		
		I _{OH} = -12mA	3.0V	2.3		2.1		
		I _{OH} = -24mA	3.0V	2.2		2.0		
		I _{OH} = 100μA	1.65V to 3.6V		0.2		0.3	
		I _{OH} = 4mA	1.65V		0.45		0.6	
.,	High-level	I _{OH} = 8mA	2.3V		0.70		0.85	
Vol	Output Voltage		2.7V		0.40		0.6	V
		I _{OH} = 12mA	3.0V		0.55		0.6	
		I _{OH} =-24mA	3.0V		0.55		0.6	
lı	Input Current	V _I =GND to 5.5V	3.6V		±5		±20	μA
I _{OZ}	Z State Leakage Current	V _O = GND or 5.5V	3.6V		±10		±20	μA
IOFF	Power Down Leakage Current	V_{I} or $V_{O} = 0V$ to 3.6V	0		10		20	μA
Icc	Supply Current	$V_{I} = GND \text{ or } V_{CC} I_{O} = 0$	3.6V		10		40	μA
ΔI _{CC}	Additional Supply Current	One input at V _{CC} –0.6V Other	2.7V to 3.6V		500		5000	μA



Switching Characteristics

	From	То	Test Conditions	Т	_A = +25°	С	-40°C t	o +85°C	-40°C to	o +125°C		
Parameter		(Output)	See Figure 1	Min	Тур	Max	Min	Max	Min	Max	Unit	
			V _{CC} = 1.8V ± 0.15V	1.0	4.5	11.8	1.0	12.3	1.0	13.8		
t _{pd}	A	Y	$V_{CC} = 2.5V$ ± 0.2V	1.0	2.7	5.8	1.0	6.3	1.0	8.4	ns	
			$V_{CC} = 2.7 V$	1.0	3.0	5.3	1.0	5.5	1.0	7.0		
			V _{CC} = 3.3V ± 0.3V	1.0	2.5	4.6	1.0	4.8	1.0	6.0		
				V _{CC} = 1.8V ± 0.15V	1.0	4.3	13.8	1.0	14.3	1.0	15.8	
t _{en}	OE	DE Y	$V_{CC} = 2.5V$ ± 0.2V	1.0	2.7	6.6	1.0	7.4	1.0	9.5	ns	
			$V_{CC} = 2.7 V$	1.0	3.3	6.4	1.0	6.6	1.0	8.5		
			V _{CC} = 3.3V ± 0.3V	1.0	2.4	5.2	1.0	5.4	1.0	7.0		
			V _{CC} = 1.8V ± 0.15V	1.0	4.3	10.6	1.0	11.1	1.0	12.6		
t _{dis}	ŌE	Y	V _{CC} = 2.5V ± 0.2V	1.0	2.2	5.1	1.0	5.6	1.0	7.7	ns	
			$V_{CC} = 2.7 V$	1.0	2.5	4.8	1.0	5.0	1.0	6.5		
			V _{CC} = 3.3V ± 0.3V	1.0	2.4	4.4	1.0	4.6	1.0	6.0		
t _{SK(0)}			V _{CC} = 3.3V ± 0.3V			1.0		1.0		1.5	ns	

Operating Characteristics (@T_A = +25°C, unless otherwise specified.)

	Parameter	Test Conditions	V _{CC} = 1.8V Typ	V _{CC} = 2.5V Typ	V _{cc} = 3.3V Typ	Unit
C _{pd}	Power dissipation capacitance per gate	f = 10 MHz	7.3	11.2	14.9	pF
Cı	Input Capacitance	$V_i = V_{CC} - or$ GND	4	4	4	pF

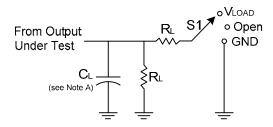
Package Characteristics

Symbol	Parameter	Test Conditions	Vcc	Min	Тур	Max	Unit	
0	Thermal Resistance	SO-14			TBD		°C 141	
θ_{JA}	Junction-to-Ambient	TSSOP-14	(Note 6)		159		°C/W	
0	Thermal Resistance	SO-14			TBD		°0.44/	
θ_{JC}	Junction-to-Case	TSSOP-14	(Note 6)		25		°C/W	

Note: 6. Test condition for SO-14 and TSSOP-14: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



Parameter Measuement Information



TEST	S1
t _{PLH} /t _{PHL}	Open
t _{PLZ} /t _{PZL}	VLOAD
tphz/tpzh	GND

Vм

́Vм

Voltage Waveform Enable and Disable Times

Low and High Level Enabling

t⊳z∟ →

t_{PZH} →

V _{cc}	Inp	uts	V _M	V _{LOAD}	C∟	RL	V۵	
	VI	t _r /t _f			_	-		
1.8V±0.15V	V _{CC}	≤2ns	V _{CC} /2	2 x V _{CC}	30pF	1ΚΩ	0.15V	
2.5V±0.2V	Vcc	≤2ns	V _{CC} /2	2 x V _{CC}	30pF	500Ω	0.15V	
2.7V	2.7V	≤2.5ns	1.5V	6V	50pF	500Ω	0.3V	
3.3V±0.3V	2.7V	≤2.5ns	1.5V	6V	50pF	500Ω	0.3V	

Output

Control

Output

Waveform 1 S1 at VLOAD

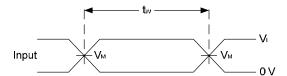
(see Note B)

Waveform 2

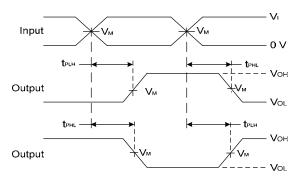
S1 at GND

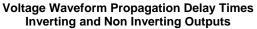
(see Note B)

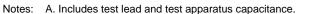
Output



Voltage Waveform Pulse Duration







- B. All pulses are supplied at pulse repetition rate \leq 10 MHz.
- C. Inputs are measured separately one transition per measurement.
- D. t_{PLZ} and t_{PHZ} are the same as $t_{dis.}$
- E. t_{PZL} and t_{PZH} are the same as t_{EN0}
- F. t_{PLH} and t_{PHL} are the same as t_{PD.}

Figure 1. Load Circuit and Voltage Waveforms

Vi

0 V

VLOAD/2

Voi

Vон

60V

Vм

→

🔶 telz

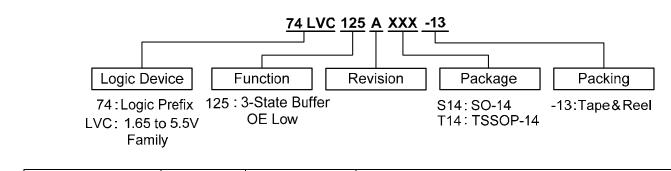
🔶 t_{РНZ}

Vol + Va

Vон V₄



Ordering Information

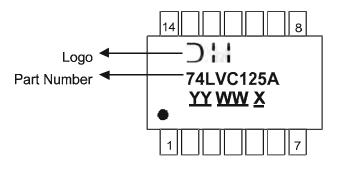


	Device	Package Packaging		13" Tape	and Reel
	Device	Code	(Note 7)	Quantity	Part Number Suffix
Pb ,	74LVC125AS14-13	S14	SO-14	2500/Tape & Reel	-13
Pb.	74LVC125AT14-13	T14	TSSOP-14	2500/Tape & Reel	-13

Notes: 7. The taping orientation and tape details can be found at http://www.diodes.com/datasheets/ap02007.pdf

Marking Information

(1) SO-14, TSSOP-14



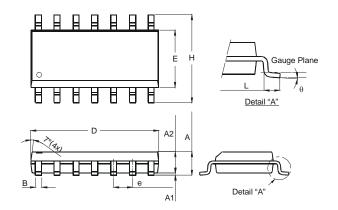
<u>YY</u> : Year : 08, 09,10~ <u>WW</u> : Week : 01~52; 52 represents 52 and 53 week <u>X</u> : Internal Code

Part Number	Package
74LVC125AS14	SO-14
74LVC125AT14	TSSOP-14



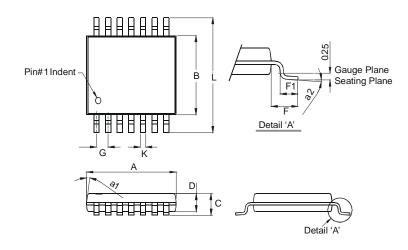
Package Outline Dimensions (All dimensions in mm.)

Package Type: SO-14



SO-14		
Dim	Min	Max
Α	1.47	1.73
A1	0.10	0.25
A2	1.45 Typ	
В	0.33	0.51
D	8.53	8.74
E	3.80	3.99
е	1.27 Typ	
н	5.80	6.20
L	0.38	1.27
θ	0°	8°
All Dimensions in mm		

Package Type: TSSOP-14

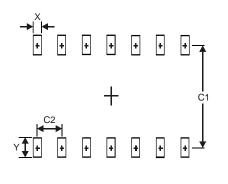


TSSOP-14		
Dim	Min	Max
a1	7° (4X)	
a2	0°	8°
Α	4.9	5.10
В	4.30	4.50
С		1.2
D	0.8	1.05
F	1.00 Тур	
F1	0.45	0.75
G	0.65 Typ	
κ	0.19	0.30
L	6.40 Тур	
All Dimensions in mm		



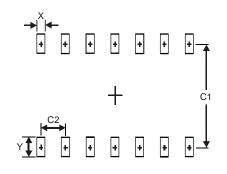
Suggested Pad Layout





Dimensions	Value (in mm)
Х	0.60
Y	1.50
C1	5.4
C2	1.27

Package Type: TSSOP-14



Dimensions	Value (in mm)
Х	0.45
Y	1.45
C1	5.9
C2	0.65



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